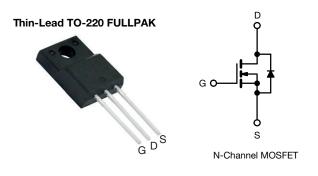
# SiHA690N60E

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**Vishay Siliconix** 

### **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.60				
Q <sub>g</sub> max. (nC)	12				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	3				
Configuration	Single				

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA690N60E-GE3			

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_c = 25$ °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current ( $T_{\rm c} = 150$ °C) e	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	I.	4.3		
Continuous drain current (T <sub>J</sub> = 150 °C) $^{\circ}$ C)	VGS at 10 V	T <sub>C</sub> = 100 °C	I00 °C	2.7	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	11		
Linear derating factor				0.23	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	9	mJ	
Maximum power dissipation			PD	29	W	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	70	V/ns	
Reverse diode dv/dt <sup>d</sup>				17	v/ns	
Soldering recommendations (peak temperature) <sup>c</sup> For 10 s			260	°C		
Mounting torque, M3 screw		-		0.6	Nm	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 0.8 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 

e. Limited by maximum junction temperature

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1 For technical questions, contact: <u>hvm@vishay.com</u>



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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 65			°C ///			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	- 4.3				°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	$V_{GS} = 0 V, I_D = 250 \mu A$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D = 2$	250 µA	3.0	-	5.0	V
Gate-source leakage	lasa	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gale-Source leakage	I <sub>GSS</sub>	١	/ <sub>GS</sub> = ± 30	V	-	-	± 1	μA
Zere gete veltage drein ourrent		V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 2.0 A	-	1.2	-	S
Dynamic								
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	347	-	
Output capacitance	C <sub>oss</sub>	$V_{\text{DS}} = 100 \text{ V},$ f = 1  MHz		-	24	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	17	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	86	-		
Total gate charge	Qg		V <sub>GS</sub> = 10 V I <sub>D</sub> = 2.0 A, V <sub>DS</sub> = 480 V		-	8	12	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V			-	3	-	
Gate-drain charge	Q <sub>gd</sub>				-	3	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	480 V, I <sub>D</sub> =	= 2.0 A,	-	9	18	
Turn-off delay time	t <sub>d(off)</sub>		$V_{GS}^{D} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	19	38	ns
Fall time	t <sub>f</sub>	]			-	22	44	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		1.1	2.3	4.6	Ω	
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.4		
Pulsed diode forward current	I <sub>SM</sub>			-	-	11	A	
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.0 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	<u> </u>			-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 2.0 \text{ A},$ di/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	1.0	2.0	μC	
Reverse recovery current	I <sub>RRM</sub>			-	13	-	A	
	יאחיי			I	<b>~</b>	I	1 .	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

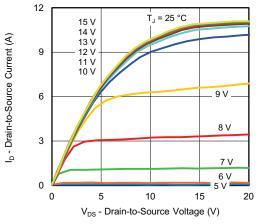


Fig. 1 - Typical Output Characteristics

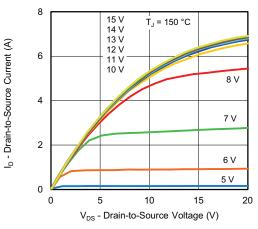


Fig. 2 - Typical Output Characteristics

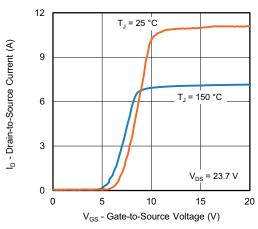


Fig. 3 - Typical Transfer Characteristics

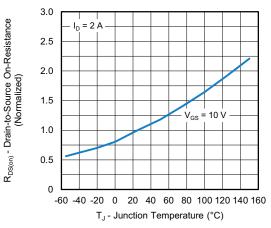


Fig. 4 - Normalized On-Resistance vs. Temperature

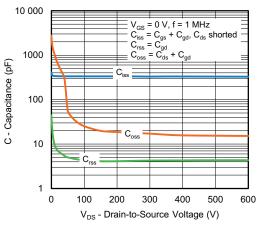


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

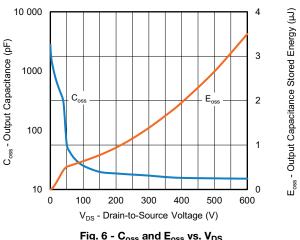


Fig. 6 - Coss and Eoss vs. VDS

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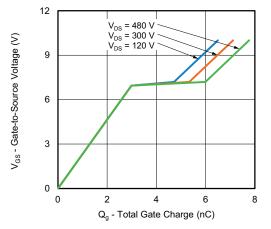


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

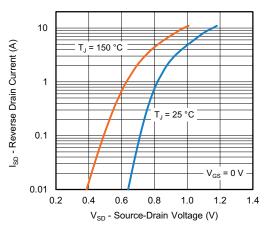


Fig. 8 - Typical Source-Drain Diode Forward Voltage

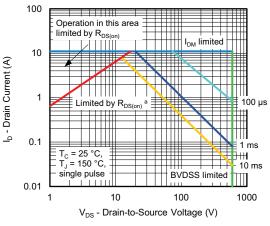


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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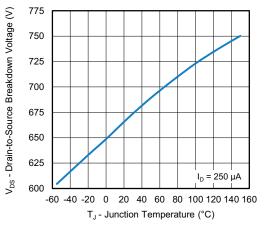
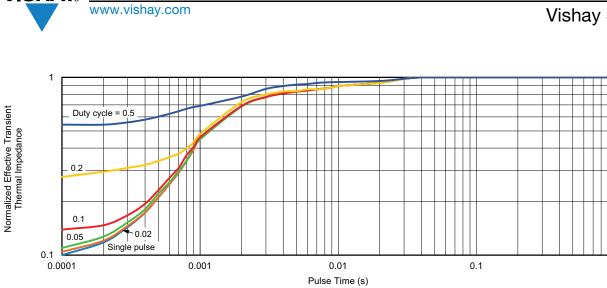


Fig. 11 - Temperature vs. Drain-to-Source Voltage





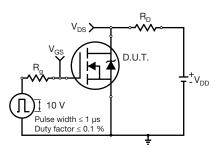


Fig. 13 - Switching Time Test Circuit

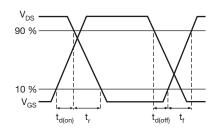


Fig. 14 - Switching Time Waveforms

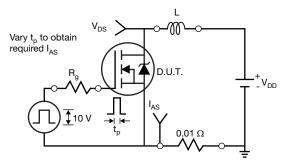


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

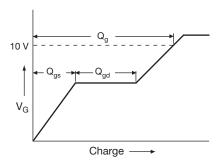


Fig. 17 - Basic Gate Charge Waveform

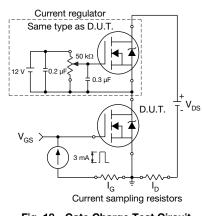


Fig. 18 - Gate Charge Test Circuit

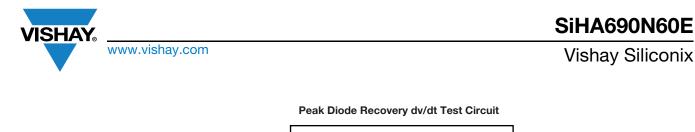
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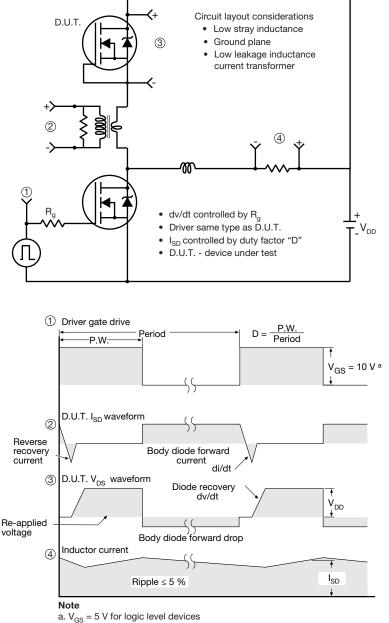


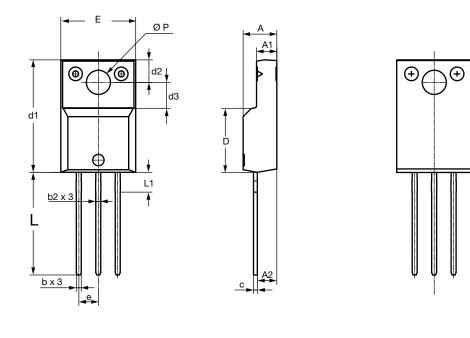
Fig. 19 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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